#### TDXXXM485



equipment



Factor Correction









current limiting







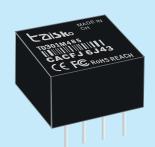






# **TD-series**





#### **Feature**

CAN isolated transceiver module It is an integrated transceiver chip Isolation chip and DC/DC Interface integrating isolated power supply Isolation transceiver module

Can be completely replaced Traditional optocoupler isolation scheme

In the past, we needed to send and receive chips Isolation chip/optocoupler

Only by isolating the power supply can it be achieved

The entire isolation and transmission plan

Now only one needs to be adopted

CAN isolated transceiver module

It can be easily achieved

Greatly simplified the customer's design

# Safety agency approval

ENI 55032:2015/A1:2020 EN IEC 62368-1:2020+A11:2020 IEC 62321-1:2013IEC 62321-2:2021IEC 62321-3-1:2013,

## ■ Up to 5-year warranty (Refer to Instruction Manual)

#### CE FCC marking

Low Voltage Directive RoHS Directive

## **■ ROHS REACH marking**

Electrical Equipment Safety Regulations RoHS Regulations

#### EMI

· PCA300F, PCA600F

Complies with FCC-B, CISPR32-B, EN55011-B, EN55032-B, VCCI-B

· PCA1000F, PCA1500F

Complies with FCC-A, CISPR32-A, EN55011-A, EN55032-A, VCCI-A

#### **EMS Compliance**: EN61204-3, EN61000-6-2

IEC60601-1-2 (2014), EN60601-1-2 (2015)

EN61000-4-2

EN61000-4-3

EN61000-4-4

EN61000-4-5

EN61000-4-6 EN61000-4-8

EN61000-4-0

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#### TDXXXM485



# RS-485 isolated www.taisko.com taisko@taisko.com

#### Single high speed small size RS-485 isolated transceiver

#### 1 Product Features:

- Single input power supply
- With isolated output power supply pin
- Automatic send and receive data function
- Up to 64 nodes can be connected
- Extremely low electromagnetic radiation EMI
- Operating temperature range: -40°C∼+85°C
- Integrated power isolation, signal isolation and

bus ESD protection function

#### 2 Product Description:

TD301M485/ TD501M485, the main function will be logic level conversion to RS-485 protocol differential level, signal isolation; is an IC integration technology, power isolation, signal isolation, RS-485 communication and bus protection in one RS-485 protocol transceiver module. The product comes with fixed-voltage isolation power supply, which can realize 2500VDC electrical isolation. The product has automatic switching transceiver function, no longer need to send and receive control through the transceiver control pin, to a certain extent, reduce the complexity of the design. The product can be easily embedded in the user's equipment, so that the equipment can easily realize the RS485 protocol network connection function.

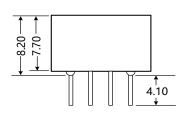
#### 3 Scope of application:

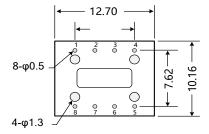
Industrial communication, coal mining industry, power monitoring, building automation...

#### 4 Appearance Dimension and Pin Description:



#### 4.1 Appearance Dimension





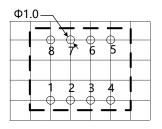
Note: Dimensions in mm:

Size unit: mm

Tolerance of terminal diameter:  $\pm 0.10$ 

Tolerance of unmarked:  $\pm 0.25$ 

## 4.2 Suggested Printing Diagram



Note: Grid spacing is 2.54\*2.54mm

#### 4.3 Pin Definition

|                      | Pin  |                                       |
|----------------------|------|---------------------------------------|
| Serial<br>Numbe<br>r | Name | Description                           |
| 1                    | RXD  | Data receiving pin                    |
| 2                    | TXD  | Data transmit pin                     |
| 3                    | GND  | Power input ground                    |
| 4                    | VCC  | Power input positive                  |
| 5                    | RGND | Isolated output power supply ground   |
| 6                    | A    | RS-485 A pin                          |
| 7                    | В    | RS-485 B pin                          |
| 8                    | VO   | Isolated output power supply positive |

#### 5 Model Number Table

| Model Number | Power Supply<br>Voltage Range<br>(VDC) | Quiescent Current<br>(mA,Typ) | Maximum Operating Current (mA) | Transmission<br>Baud Rate<br>(kbps) | Number of<br>nodes<br>(pcs) | Туре          |
|--------------|--|-------------------------------|--------------------------------|-------------------------------------|-----------------------------|---------------|
| TD301M485    | 3.3<br>(3.15~3.45)                     | 22                            | 90                             | 500                                 | 64                          | High<br>Speed |
| TD501M485    | 5<br>(4.75~5.25)                       | 18                            | 70                             | 500                                 | 64                          | High<br>speed |

#### 6 Specifications

#### 6.1 Maximum Limit Parameters

Use beyond the following limits may result in permanent damage to the module.

| •             |           |         |         |         |       |
|---------------|-----------|---------|---------|---------|-------|
| ltem          | Condition | Minimum | Nominal | Maximum | Unit  |
| цеш           | Condition | value   | value   | value   | Offic |
| Input Voltage | TD301M485 | -0.7    | 3.3     | 5       | \/ da |
| Range         | TD501M485 | -0.7    | 5       | 7       | V dc  |



| Item               | Condition                  | Minimum<br>value | Nominal value | Maximum<br>value | Unit |
|--------------------|----------------------------|------------------|---------------|------------------|------|
| Pin Soldering      | Manual soldering @ 3~5 sec |                  | 370           |                  | °C   |
| Temperature        | Wave soldering @5~10 sec   |                  | 265           |                  |      |
| Thermal Unplugging |                            | Not support      |               |                  |      |

Note: This series of modules do not have input anti-reverse connection function, it is strictly prohibited to reverse the positive and negative inputs, otherwise it will cause irreversible damage to the module.

#### 6.2 Input Characteristics

| Item                                |                                  | Symbol          | Condition               | Minimum<br>value | Nominal<br>value           | Maximum<br>value   | Unit            |
|-------------------------------------|----------------------------------|-----------------|-------------------------|------------------|----------------------------|--------------------|-----------------|
| Innut Valtas                        | ••                               | \ \/            | TD301M485               | 3.15             | 3.3                        | 3.45               |                 |
| Input Voltaç                        | je                               | V <sub>cc</sub> | TD501M485               | 4.75             | 5                          | 5.25               |                 |
| TYD Logic Loyel                     | High Level                       | V <sub>IH</sub> |                         | 0.7Vcc           |                            | Vcc+0.5            |                 |
| TXD Logic Level                     | Low Level                        | VIL             |                         | 0                |                            | 0.3V <sub>CC</sub> | V <sub>DC</sub> |
|                                     | High Level                       | V <sub>OH</sub> | I <sub>RXD</sub> = -2mA | 2.0              |                            |                    | V DC            |
| RXD Logic Level                     | Low level                        | Vol             | I <sub>RXD</sub> = 2mA  |                  |                            | 0.8                |                 |
| TXD drive cur                       | TXD drive current I <sub>T</sub> |                 |                         |                  |                            | 2                  | A               |
| RXD output current I <sub>RXD</sub> |                                  |                 |                         |                  | 2                          | mA                 |                 |
| Sorial                              | Serial Interface                 |                 | TD301M485               | 3                | 3.3V Standard U            | ART Interface      |                 |
| Senai                               |                                  |                 | TD501M485               |                  | 5V standard UART interface |                    |                 |

#### 6.3 Output Characteristics

| Item                                    | Symbol | Condition                  | Minimum<br>value      | Nominal<br>value | Maximum<br>value | Unit |
|---|--------|----------------------------|-----------------------|------------------|------------------|------|
| Built-in isolated output supply voltage | Vo     | Nominal Input Voltage      |                       |                  |                  | VDC  |
| Differential Output Voltage (A-B)       | Vod    | Nominal input voltage with | 1.5                   |                  | VO               |      |
| Differential output current (A-B)       | Гор    | differential load of 54 Ω  | 28                    |                  |                  | mA   |
| Bus Interface Protection                |        |                            | ESD static protection |                  |                  |      |

#### 6.4 Transmission characteristics

| Item   | Symbol | Condition    | Minimum<br>value | Nominal<br>value | Maximum<br>value | Unit |
|--|--------|--------------|------------------|------------------|------------------|------|
| Built-in pull-up and pull-<br>down resistors |        |              |                  | 24               |                  | 1.0  |
| Transceiver Input Impedance                  |        | -7V≤VCM≤+12V | 96               |                  |                  | kΩ   |
| Data transmission delay                      |        |              |                  | 180              |                  | ns   |



| Item                 | Symbol | Condition | Minimum<br>value | Nominal<br>value | Maximum<br>value | Unit |
|----------------------|--------|-----------|------------------|------------------|------------------|------|
| Data reception delay |        |           |                  | 120              |                  |      |
|                      |        |           |                  |                  |                  | ,    |

#### 6.5 Truth Table Characteristics

| Item              | Input   | Output          |       |  |
|-------------------|---|-----------------|-------|--|
|                   | TXD   | A               | TXD A |  |
| Transmit Function | 1   | 1               | 0     |  |
|                   | 110   | 1100            | 1     |  |
|                   | V <sub>A</sub> -V <sub>B</sub>                  | RXD             |       |  |
| Descive Function  | ≥ -10mV   | 1               |       |  |
| Receive Function  | ≤-200mV   | 0 ≤-200mV       |       |  |
|                   | -200mV <v<sub>A-V<sub>B</sub>&lt; -10mV</v<sub> | Uncertain state |       |  |

#### 6.6 General Characteristics

| Item   | Condition  | Minimum<br>value   | Nominal<br>value | Maximum<br>value | Unit |  |
|--|--|--|------------------|------------------|------|--|
| Electrical isolation                             |  | Isolation at both ends (input and output are isolated from each other) |                  |                  |      |  |
| Isolation voltage                                | Test time 1 minute, Leakage current <5mA,<br>Humidity <95%   |  | 2.5K             |                  | VDC  |  |
| Operating Temperature Range                      | Output is full load  | -40  |                  | +85              | °C   |  |
| Storage temperature                              |  | -55  |                  | +105             | °C   |  |
| Storage humidity                                 | Non-condensing   |  |                  | 95               | %    |  |
| Temperature rise of the housing during operation |  |  | 20               |                  | °C   |  |
| Operating environment                            | The product may be damaged by the presence of dust, strong vibrations, shocks, and gases that corrode the components of the product. |  |                  |                  |      |  |

#### 6.7 Physical Characteristics

| Item               | Conditions of use                                      |
|--------------------|--|
| Enclosure Material | Black flame retardant heat resistant plastic (UL94-V0) |
| Package size       | 12.70*10.16*7.70mm                                     |
| Weight             | 2.0g (nominal)   |
| Cooling Method     | Natural air cooling                                    |

#### 6.8 EMC Characteristics



| Classification | Item                        | Parameter  | Class           |
|----------------|-----------------------------|--|-----------------|
|                | Electrostatic               | IEC/EN 61000-4-2 Contact ±4KV/Air ±8KV (bare metal)  | Perf.Criteria B |
|                | discharge immunity          | IEC/EN 61000-4-2 Contact $\pm$ 8KV/Air $\pm$ 15KV (see Figure 3 for recommended circuit)                     | Perf.Criteria B |
| EMC            | Pulse group immunity        | IEC/EN 61000-4-4 ±2KV  | Perf.Criteria B |
| EMS            | Lightning surge immunity    | IEC/EN 61000-4-5 Common mode ±2KV (bare metal)   | Perf.           |
|                |                             | IEC/EN 61000-4-5 Differential mode $\pm 2$ KV, common mode $\pm 4$ KV (see Figure 3 for recommended circuit) | Perf.Criteria B |
|                | Conducted Nuisance Immunity | IEC/EN 61000-4-6 3Vr.m.s   | Perf.           |

#### 7 Design Reference

#### 7.1 Typical Application

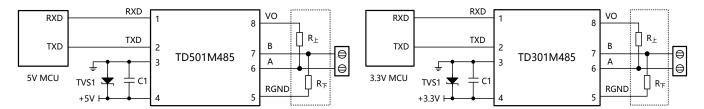


Figure 1. MCU 5V Power Supply Application Circuitry

Figure 2. MCU 3.3V Power Supply Application Circuitry

Figure 1 shows the connection diagram between the 5V MCU system UART interface and the TD501M485 isolated transceiver module. The module must be powered by a 5V power supply, and the module's TXD and RXD pin interfaces match the level of 5V, and do not support the 3.3V system level. Figure 2 shows the connection diagram of the 3.3V MCU system UART interface with the TD301M485 isolated transceiver module, the module must be powered by a 3.3V power supply, the module's TXD, RXD pin interface matching level is 3.3V, does not support 5V system level.

#### 7.2 EMC Typical Recommended Circuit

As the module internal A/B line with pull-up and down resistors and ESD protection devices, so generally used in good environmental conditions without the need to add ESD protection devices, such as 7.1 typical applications shown in the typical connection circuit diagram. However, if the application environment is more severe (such as high-voltage power, lightning and other environments), it is recommended that the user must be in the module at the A/B line end of the external pull-up and down resistors, TVS tubes, common-mode inductors, lightning tubes, shielded twisted-pair cables, or the same network of



single-point connection to the earth and other protective measures.

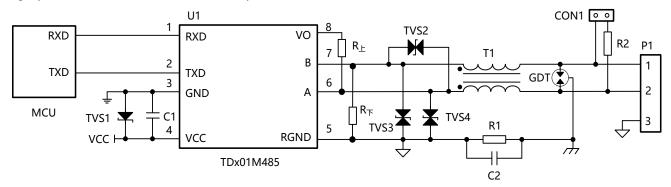


Figure 3. EMC Recommended Circuitry

If you need to meet the specific surge level requirements, it is recommended to use the recommended protection circuit shown in Figure 3, Table 1 gives a set of recommended device parameters, the recommended circuit diagram and parameter values are for reference only, please determine the appropriate parameter values according to the actual situation.

Table 1. EMC Recommended Parameters

| Label | Model          | Marker     | Model No.           |
|-------|----------------|------------|---------------------|
| C1    | 10 μ F, 25V    | TVS1       | SMBJ5.0A            |
| C2    | 102, 2KV, 1206 | TVS2       | SMBJ12CA            |
| GDT   | 3RL090M-5-S    | TVS3, TVS4 | SMBJ6.5CA           |
| R1    | 1MΩ, 1206      | T1         | B82793S0513N201     |
| R2    | 120Ω, 1206     | U1         | TDx01D485H-A Module |

#### 8 Precautions for Product Use

#### 8.1 MCU IO Port Level Matching

The interface matching level of TXD and RXD pins of TD501M485 is 5V, 3.3V system level is not supported; the interface matching level of TXD and RXD pins of TD301M485 is 3.3V, 5V system level is not supported.

#### 8.2 Module RS485 A-B bus level threshold description

From the truth table characteristics can be seen, the series of embedded isolated RS-485 transceiver module when the A/B line differential voltage is greater than or equal to +200mV, the module receives a high level; when the A/B line differential voltage is greater than or equal to -200mV, the module receives a low level; when the A/B line differential voltage is greater than -200mV and less than +200mV, the module receives the level of uncertainty, the design should ensure that the module receives is not in the -200mV and less than +200mV. The design should ensure that the module reception is not in this state. So users in the design or application of RS-485 network, according to the actual situation to decide whether to add  $120\,\Omega$  termination resistor. Principle of use: Regardless of whether the RS-485 network is in a static or dynamic situation, it must be ensured that the differential voltage of A/B line is not between -200mV and +200mV, or communication errors will occur.

#### 8.3 Module Pin Description

TDXXXM485



# RS-485 isolated www.taisko.com taisko@taisko.com

If the module does not use pins 5 and 8, please leave these pins empty;

Users must avoid short-circuiting between VO pin and RGND pin, otherwise the module will be damaged. In addition, it is better to use VO pin only for pull-up resistor circuit, and do not use it for other circuits to supply power.

#### 8.4 The use of shielded wires

Please use shielded twisted-pair cable for data transmission line, and connect the shielding layer of the same network to the earth at a single point; if you require RS-485 network to have better anti-jamming ability, you can use double shielded twisted-pair cable, and RGND of each node should be connected to the inner shielding layer, and the outer shielding layer should be connected to the earth at a single point.

#### 8.5 External pull-up/down resistor

If the application environment is relatively harsh (such as high-voltage power, lightning and other environments) need to be added to the ESD protection device, you need to connect the appropriate external pull-up and pull-down resistors to match the equivalent capacitance of the ESD protection device, used to improve the quality of the communication signal waveform.